



DDR 24-Bit to 48-Bit Registered Buffer

Recommended Application:

DDR Memory Modules

Product Features:

- Differential clock signals
- Meets SSTL_2 signal data
- Supports SSTL_2 class II specifications on outputs
- low-voltage operation
 - VDD = 2.3V to 2.7V
- Available in 114 ball BGA package.

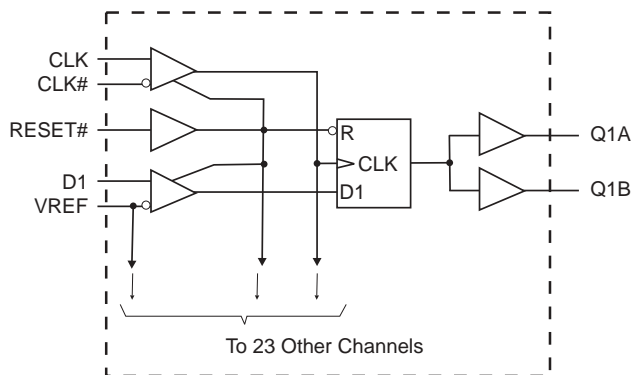
Truth Table¹

Inputs				Q Outputs
RESET#	CLK	CLK#	D	Q
L	X or Floating	X or Floating	X or Floating	L
H	↑	↓	H	H
H	↑	↓	L	L
H	L or H	L or H	X	Q ₀ ⁽²⁾

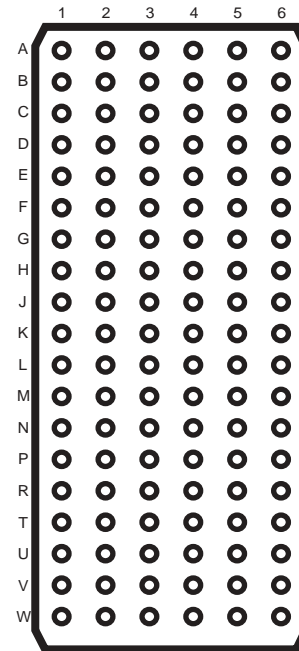
Notes:

1. H = High Signal Level
L = Low Signal Level
↑ = Transition LOW-to-HIGH
↓ = Transition HIGH -to- LOW
X = Irrelevant
2. Output level before the indicated steady state input conditions were established.

Block Diagram



Pin Configuration



114-Pin Ball BGA

Pin Configuration Assignments

	1	2	3	4	5	6
A	Q2A	Q1A	CLK	CLK#	Q1B	Q2B
B	Q3A	VDDQ	GND	GND	VDDQ	Q3B
C	Q5A	Q4A	VDDQ	VDDQ	Q4B	Q5B
D	Q7A	Q6A	GND	GND	Q6B	Q7B
E	Q8A	GND	VDDQ	VDDQ	GND	Q8B
F	Q10A	Q9A	VDDQ	VDDQ	Q9B	Q10B
G	Q12A	Q11A	GND	GND	Q11B	Q12B
H	Q13A	VDD	VDDQ	VDDQ	VDD	Q13B
J	Q14A	Q15A	GND	GND	Q15B	Q14B
K	Q17A	Q16A	VDDQ	VDDQ	Q16B	Q17B
L	Q18A	Q19A	GND	GND	Q19B	Q18B
M	Q20A	VDDQ	GND	GND	VDDQ	Q20B
N	Q22A	Q21A	VDDQ	VDDQ	Q21B	Q22B
P	Q23A	VDDQ	GND	GND	VDDQ	Q23B
R	Q24A	VDD	RESET#	VREF	VDD	Q24B
T	D2	D1	D6	D18	D13	D14
U	D4	D3	D10	D22	D15	D16
V	D5	D7	D11	D23	D19	D17
W	D8	D9	D12	D24	D21	D20



General Description

The 24-bit to 48-bit ICSSSTV32852 is a universal bus driver designed for 2.3V to 2.7V VDD operation and SSTL_2 I/O levels except for the RESET# input which is LVCMOS.

Data flow from D to Q is controlled by the differential clock, CLK, CLK# and RESET#. Data is triggered on the positive edge of CLK. CLK# must be used to maintain noise margins. RESET# must be supported with LVCMOS levels as VREF may not be stable during power-up. RESET# is asynchronous and is intended for power-up only and when LOW assures that all of the registers reset to the LOW state, Q outputs are LOW, and all input receivers, data and clock are switched off.

The ICSSSTV32852 supports low-power standby operation. When RESET# is LOW, the differential input receivers are disabled, and are allowed. In addition, when RESET# is LOW, all registers are reset, and all outputs are forced LOW. The LVCMOS RESET# input must always be held at a valid logic HIGH or LOW level.

To ensure defined outputs from the register before a stable clock has been supplied, RESET# must be held in the LOW state during power up.

In the DDR DIMM application RESET# is specified to be completely asynchronous with respect to CK and CK#. Therefore, no timing relationship can be guaranteed between the two. When entering RESET#, the register will be cleared and the outputs will be driven LOW quickly, relative to the time to disable the differential input receivers, thus ensuring no glitches on the output. However, when coming out of RESET#, the register will become active quickly, relative to the time to enable the differential input receivers. When the data inputs are LOW, and the clock is stable, during the time from the LOW-to-HIGH transition of RESET# until the input receivers are fully enabled, the design must ensure that the outputs will remain LOW.

Pin Configuration

PIN NUMBER	PIN NAME	TYPE	DESCRIPTION
R1,P1, N1, N2, M1, L2, L1, K1, K2, J2, J1, H1, G1, G2, F1, F2, E1, D1, D2, C1, C2, B1, A1, A2	Q (24:1)A	OUTPUT	Data output
R6, P6, N6, N5, M6, L5, L6, K6, K5, J5, J6, H6, G6, G5, F6, F5, E6, D6, D5, C6, C5, B6, A6, A5	Q (24:1)B	OUTPUT	Data output
E2, B3, D3, G3, J3, L3, M3, P3, B4, D4, G4, J4, L4, M4, P4, E5	GND	PWR	Ground
B2, M2, P2, C3, E3, F3, H3, K3, N3, C4, E4, F4, H4, K4, N4, B5, M5, P5	VDDQ	PWR	Output supply voltage, 2.5V nominal
W4, V4, U4, W5, W6, V5, T4, V6, U6, U5, T6, T5, W3, V3, U3, W2, W1, V2, T3, V1, U1, U2, T1, T2	D (24:1)	INPUT	Data input
A3	CLK	INPUT	Positive master clock input
A4	CLK#	INPUT	Negative master clock input
H2, H5, R2, R5	VDD	PWR	Core supply voltage, 2.5V nominal
R3	RESET#	INPUT	Reset (active low)
R4	VREF	INPUT	Input reference voltage, 1.25V nominal



Absolute Maximum Ratings

Storage Temperature	-65°C to +150°C
Supply Voltage	-0.5 to 3.6V
Input Voltage ¹	-0.5 to VDD +0.5
Output Voltage ^{1,2}	-0.5 to VDDQ +0.5
Input Clamp Current	±50 mA
Output Clamp Current	±50mA
Continuous Output Current	±50mA
VDD, VDDQ or GND Current/Pin	±100mA
Package Thermal Impedance ³	??°C/W

Notes:

1. The input and output negative voltage ratings may be excluded if the input and output clamp ratings are observed.
2. This current will flow only when the output is in the high state level $V_0 > V_{DDQ}$.
3. The package thermal impedance is calculated in accordance with JESD 51.

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Recommended Operating Conditions

PARAMETER	DESCRIPTION	MIN	TYP	MAX	UNITS
V _{DD}	Supply Voltage	2.3	2.5	2.7	V
V _{DDQ}	I/O Supply Voltage	2.3	2.5	2.7	
V _{REF}	Reference Voltage V _{REF} = 0.5X V _{DDQ}	1.15	1.25	1.35	
V _{TT}	Termination Voltage	V _{REF} -0.04	V _{REF}	V _{REF} -0.04	
V _I	Input Voltage	0		V _{DD}	
V _{IH(DC)}	DC Input High Voltage	Data Inputs	V _{REF} +0.15		
V _{IH(AC)}	AC Input High Voltage		V _{REF} +0.31		
V _{IL(DC)}	DC Input Low Voltage			V _{REF} -0.15	
V _{IL(AC)}	AC Input Low Voltage			V _{REF} -0.31	
V _{IH}	Input High Voltage Level	RESET#	1.7		
V _{IL}	Input Low Voltage Level			0.7	
V _{ICR}	Common mode Input Range	CLK, CLK#	0.97	1.53	
V _{ID}	Differential Input Voltage		0.36		
V _{IX}	Cross Point Voltage of Differential Clock Pair		(V _{DDQ} /2)-0.2	(V _{DDQ} /2)+0.2	
I _{OH}	High-Level Output Current			TBD	mA
I _{OL}	Low-Level Output Current			TBD	
T _A	Operating Free-Air Temperature	0		70	°C

¹Guaranteed by design, not 100% tested in production.



Electrical Characteristics - DC

$T_A = 0 - 70^\circ \text{C}$; $V_{DD} = 2.5 \text{ V} \pm 200\text{mV}$, $V_{DDQ} = 2.5\text{V} \pm 200\text{mV}$; (unless otherwise stated)

SYMBOL	PARAMETERS	CONDITIONS	V_{DD}	MIN	TYP	MAX	UNITS
V_{IK}		$I_I = -18\text{mA}$	2.3V			-1.2	V
V_{OH}		$I_{OH} = -100\mu\text{A}$	2.3V-2.7	$V_{DD} - 0.2$			
		$I_{OH} = -16\text{mA}$	2.3V	1.95			
V_{OL}		$I_{OL} = 100\mu\text{A}$	2.3-2.7V			0.2	
		$I_{OL} = 16\text{mA}$	2.3V			0.35	
I_I	All Inputs	$V_I = V_{DD}$ or GND	2.7V			± 5	μA
I_{DD}	Standby (Static)	RESET# = GND				.01	μA
	Operating (Static)	$V_I = V_{IH}(\text{AC}\#)$ or $V_{IL}(\text{AC})$, RESET# = V_{DD}				45	mA
I_{DDQ}	Dynamic operating clock only	RESET = V_{DD} , $V_I = V_{IH}(\text{AC})$ or $V_{IL}(\text{AC})$, CK and CK# switching 50% duty cycle. CK, CK# @ 200MHz.	$I_O = 0$ 2.7V			35	μ/clock MHz
	Dynamic Operating per each data input	RESET# = V_{DD} , $V_I = V_{IH}(\text{AC})$ or $V_{IL}(\text{AC})$, CK and CK# switching 50% duty cycle. One data input switching at half clock frequency, 50% duty cycle				TBD	$\mu\text{A}/\text{clock}$ MHz/data
r_{OH}	Output High	$I_{OH} = 20\text{mA}$	2.3-2.7V				Ω
r_{OL}	Output Low	$I_{OL} = 20\text{mA}$	2.3-2.7V				Ω
$r_{O(D)}$	[$r_{OH} - r_{OL}$] each separate bit	$I_O = 20\text{mA}$, $T_A = 25^\circ \text{C}$	2.5V				Ω
C_i	Data Inputs	$V_I = V_{REF} \pm 350\text{mV}$	2.5V	2.5		3.5	pF
	CK and CK#	$V_{ICR} = 1.25\text{V}$, $V_{I(PP)} = 360\text{mV}$		2.5		3.5	

Notes:

1 - Guaranteed by design, not 100% tested in production.



Timing Requirements

(over recommended operating free-air temperature range, unless otherwise noted)

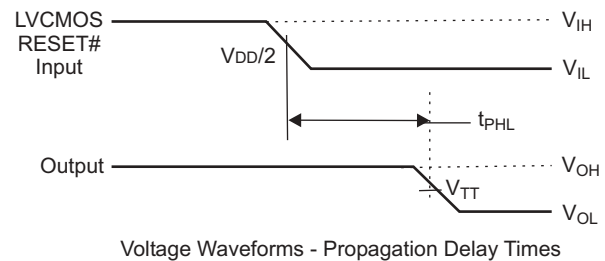
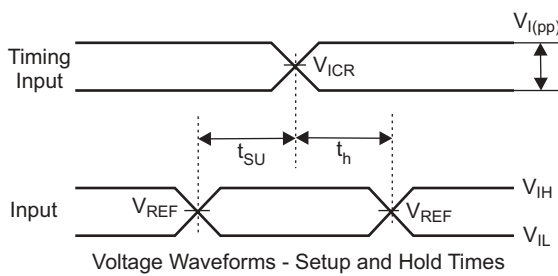
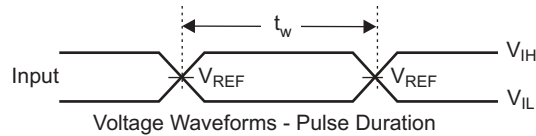
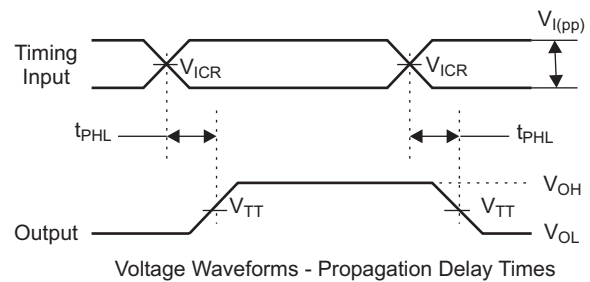
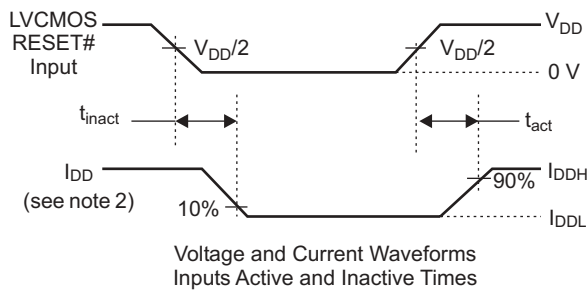
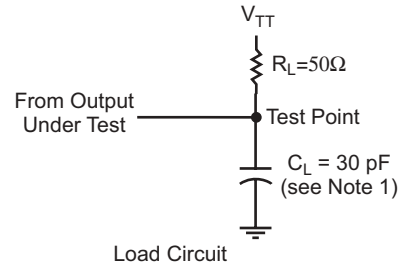
SYMBOL	PARAMETERS	$V_{DD} = 2.5V \pm 0.2V$		UNITS
		MIN	MAX	
f_{clock}	Clock frequency		200	MHz
t_{PD}	Clock to output time		2.6	ns
t_{RST}	Reset to output time		4	ns
t_{SL}	Output slew rate	1	4	V/ns
t_{SU}	Setup time, fast slew rate ^{2, 4}	Data before CK-, CK#	0.75	ns
	Setup time, slow slew rate ^{3, 4}		0.9	ns
T_h	Hold time, fast slew rate ^{2, 4}	Data after CK-, CK#	0.50	ns
	Hold time, slow slew rate ^{3, 4}		0.70	ns

- Notes:**
- 1 - Guaranteed by design, not 100% tested in production.
 - 2 - For data signal input slew rate³ 1V/ns.
 - 3 - For data signal input slew rate³ 0.5V/ns and < 1V/ns.
 - 4 - CLK, CLK# signals input slew rates are³ 1V/ns.

Switching Characteristics

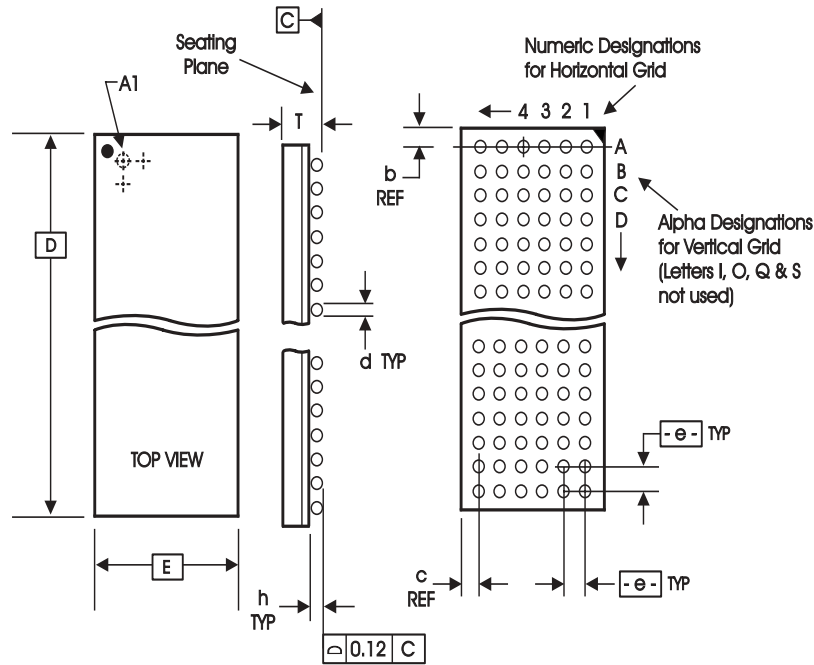
(over recommended operating free-air temperature range, unless otherwise noted)

SYMBOL	From (Input)	To (Output)	$V_{DD} = 2.5V \pm 0.2V$			UNITS
			MIN	TYP	MAX	
f_{max}			200			MHz
t_{PD}	CLK, CLK#	Q	1.1		2.6	ns
t_{ph1}	CLK, CLK#	Q			5	ns



Parameter Measurement Information ($V_{DD} = 2.5V \pm 0.2V$)

- Notes:
1. C_L includes probe and jig capacitance.
 2. I_{DD} tested with clock and data inputs held at V_{DD} or GND, and $I_o = 0\text{ mA}$.
 3. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_o = 50\Omega$, input slew rate = $1\text{ V/ns} \pm 20\%$ (unless otherwise specified).
 4. The outputs are measured one at a time with one transition per measurement.
 5. $V_{TT} = V_{REF} = V_{DDQ}/2$
 6. $V_{IH} = V_{REF} + 310\text{ mV}$ (ac voltage levels) for differential inputs. $V_{IH} = V_{DD}$ for LVC MOS input.
 7. $V_{IL} = V_{REF} - 310\text{ mV}$ (ac voltage levels) for differential inputs. $V_{IL} = \text{GND}$ for LVC MOS input.
 8. t_{PLH} and t_{PHL} are the same as t_{pd}



D	E	T Min/Max	e	----- BALL GRID -----			d	h Min/Max	REF. DIMENSIONS	
				HORIZ	VERT	TOTAL			b	c
16.00 Bsc	5.50 Bsc	1.30/1.50	0.80 Bsc	6	19	114	0.46	0.31/0.41	0.80	0.75

ALL DIMENSIONS IN MILLIMETERS

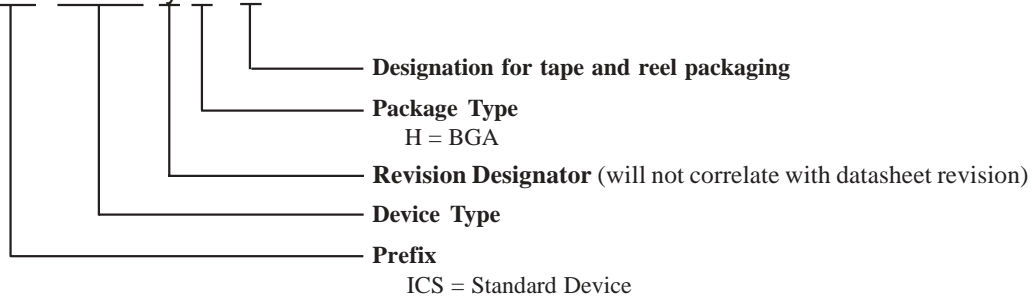
10-0055

Ordering Information

ICSSSTV32852yFT

Example:

ICS XXXX y H - T



Registered Company



9001

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